

MITSUBISHI (DGTL LOGIC)

**M54976P****BI-CMOS 8-BIT PARALLEL-INPUT, LATCHED DRIVER****DESCRIPTION**

The M54976P is a semiconductor integrated circuit fabricated using Bi-CMOS technology. It contains bipolar 8 output drivers of CMOS latch.

**FEATURES**

- Enable input for output control
- Low supply current .....  $I_{CC} \leq 10 \mu A$  at standby
- Input level is compatible with standard CMOS
- Driver : Withstand voltage .....  $BV_{CEO} \geq 30$   
Large drive current ..... ( $I_{O(max)} = 300mA$ )
- Wide operating temperature range .....  $T_a = -20 \sim +75^\circ C$

**APPLICATION**

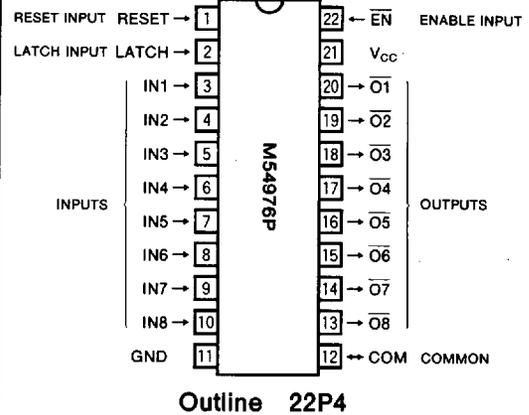
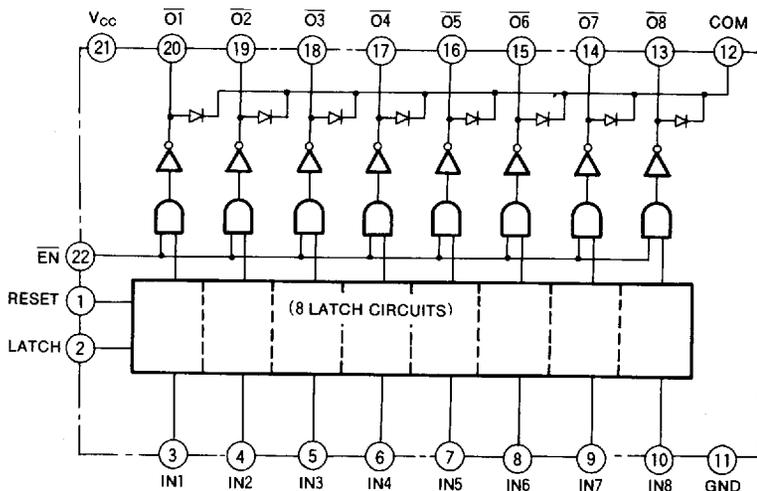
Thermal printer head dot driver, Relay driver, Solenoid driver

**FUNCTION**

When data is applied to inputs IN1-IN8 and LATCH input is set to "H", the data will be latched with the truth table. Note that when an "H" signal is applied to the RESET input, the latch will maintain the reset state.

When the EN input is set to "L" and the data maintained in the latch are "H", the corresponding output will be ON and become "L".

When both the LATCH and RESET inputs are "L", the latch will maintain the prior state irrespective of input signals IN1-IN8.

**PIN CONFIGURATION (TOP VIEW)****BLOCK DIAGRAM**

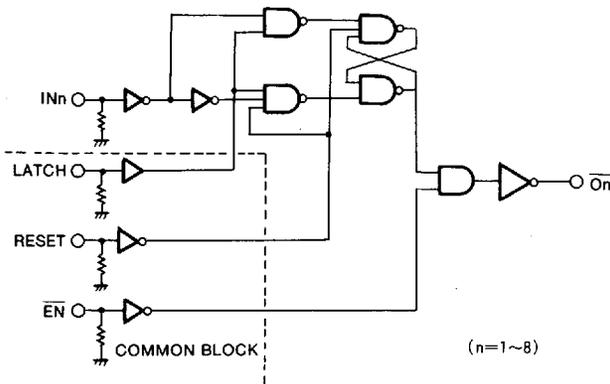
BI-CMOS 8-BIT PARALLEL-INPUT, LATCHED DRIVER

TRUTH TABLE

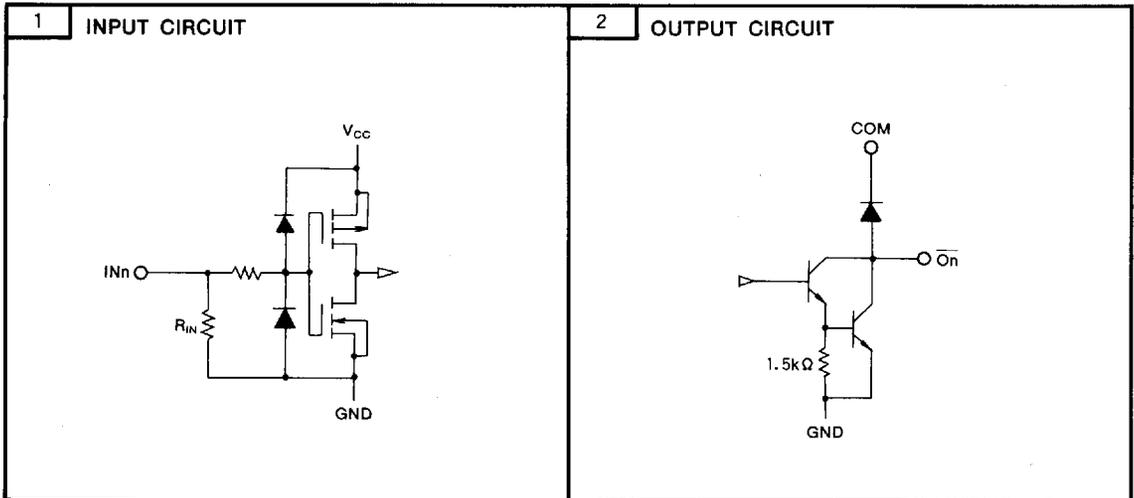
INPUTS				OUTPUT $\overline{O_n}$	
$IN_n$	LATCH	RESET	EN	t-1	t
L	H	L	L	X	H
H	H	L	L	X	L
X	X	H	X	X	H
X	X	X	H	X	H
X	L	L	L	L	L
X	L	L	L	H	H

L : "L" level  
 H : "H" level  
 X : Irrelevant  
 t-1 : Previous state  
 t : Present state  
 Output H is in the OFF state  
 Output L is in the ON state

LOGIC DIAGRAM (1 CIRCUIT)



INPUT/OUTPUT EQUIVALENT CIRCUIT SCHEMATICS



**BI-CMOS 8-BIT PARALLEL-INPUT, LATCHED DRIVER**

**ABSOLUTE MAXIMUM RATINGS** ( $T_a = -20^{\circ}\text{C} \sim +75^{\circ}\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{CC}$	Supply voltage		$-0.5 \sim +8$	V
$V_I$	Input voltage		$-0.5 \sim V_{CC} + 0.5$	V
$V_O$	Output voltage	Output is OFF	$-0.5 \sim +30$	V
$I_O$	Output current	Output is on	350	mA
$P_d$	Power dissipation	$T_a = 25^{\circ}\text{C}$	1.42	W
$T_{opr}$	Operating temperature		$-20 \sim +75$	$^{\circ}\text{C}$
$T_{stg}$	Storage temperature		$-55 \sim +125$	$^{\circ}\text{C}$

**RECOMMENDED OPERATING CONDITIONS** ( $T_a = -20 \sim +75^{\circ}\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Limits			Unit
			Min	Typ	Max	
$V_{CC}$	Supply voltage		4	5	6	V
$V_O$	Applied output voltage	When output is OFF			30	V
$I_O$	Output current (per circuit)	All outputs ON simultaneously Duty cycle less than 25%			300	mA

**ELECTRICAL CHARACTERISTICS** ( $T_a = +25^{\circ}\text{C}$ ,  $V_{CC} = 5\text{V}$ , unless otherwise noted)

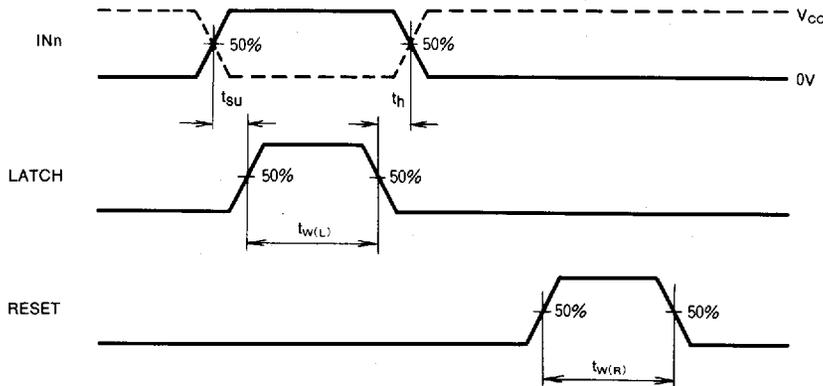
Symbol	Parameter	Test pin	Test conditions	Limits			Unit
				Min	Typ	Max	
$V_{IH}$	High-level input voltage	1~10	$T_a = -20 \sim +75^{\circ}\text{C}$	$0.7V_{CC}$		$V_{CC}$	V
$V_{IL}$	Low-level input voltage	22		0		$0.3V_{CC}$	V
$R_{IN}$	Input resistance			50			k $\Omega$
$V_{OL1}$	Low-level output voltage	13~20	$I_{OL} = 100\text{mA}$			1.2	V
$V_{OL2}$			$I_{OL} = 200\text{mA}$			1.4	V
$V_{OL3}$			$I_{OL} = 300\text{mA}$			1.6	V
$I_{OLK}$	Output leakage current	13~20	$V_O = 30\text{V}$			50	$\mu\text{A}$
$V_F$	Clamp diode forward current	13~20	$I_F = 300\text{mA}$			2	V
$I_R$	Clamp diode reverse current		$V_R = 30\text{V}$			50	$\mu\text{A}$
$I_{CC1}$	Supply current	21	All inputs are 0V, all outputs OFF			10	$\mu\text{A}$
$I_{CC2}$			Output : 1 circuit ON			1.4	mA

**BI-CMOS 8-BIT PARALLEL-INPUT, LATCHED DRIVER**

**REQUIRED TIMING CONDITIONS** ( $T_a = -20 \sim +75^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$t_{w(L)}$	Latch pulse width		0.1			$\mu\text{S}$
$t_{w(R)}$	Reset pulse width		0.1			$\mu\text{S}$
$t_{su}$	Data setup time		0			$\mu\text{S}$
$t_h$	Data hold time		0.1			$\mu\text{S}$

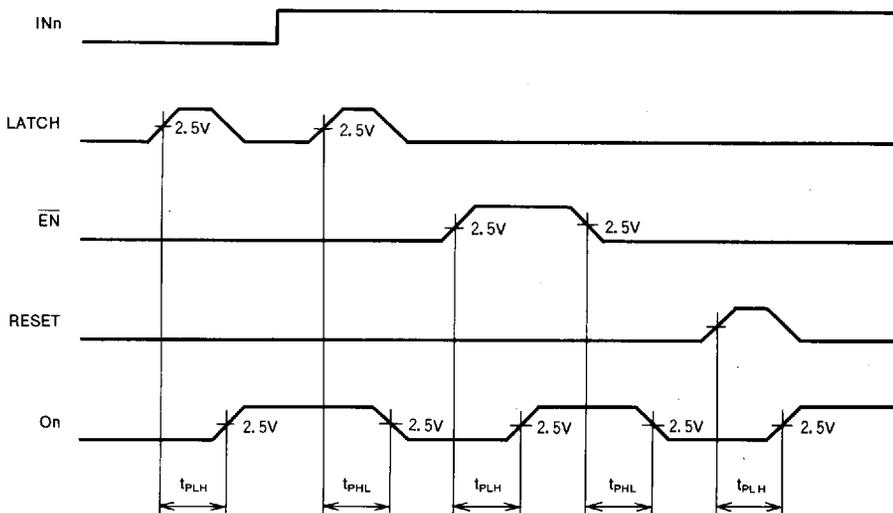
**TIMING DIAGRAM**



**SWITCHING CHARACTERISTICS** ( $T_a = +25^\circ\text{C}$ ,  $V_{cc} = 5\text{V}$ )

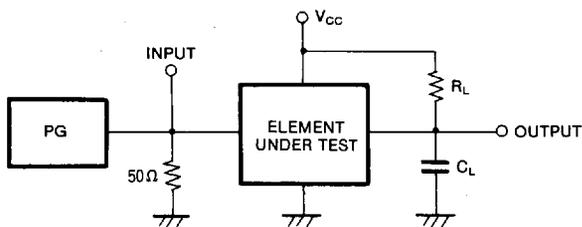
Symbol	Parameter	Test conditions	Limits			Unit	
			Min	Typ	Max		
$t_{PLH}$	Low to high-level output propagation time (Input LATCH to output $\bar{O}n$ )	$V_{IH} = 5\text{V}$ $V_{IL} = 0\text{V}$ $R_L = 100\Omega$ $C_L = 15\text{pF}$ (Note 1)		(0.6)	2	$\mu\text{S}$	
$t_{PHL}$	High to low-level output propagation time (Input LATCH to output $\bar{O}n$ )			(0.1)	0.5	$\mu\text{S}$	
$t_{PLH}$	Low to high-level output propagation time (Input $\bar{E}N$ to output $\bar{O}n$ )				(0.6)	2	$\mu\text{S}$
$t_{PHL}$	High to low-level output propagation time (Input $\bar{E}N$ to output $\bar{O}n$ )				(0.1)	0.5	$\mu\text{S}$
$t_{PLH}$	Low to high-level output propagation time (Input RESET to output $\bar{O}n$ )				(0.6)	2	$\mu\text{S}$

**TIMING DIAGRAM**



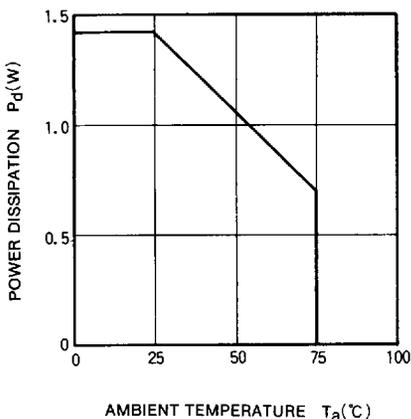
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(Note 1) TEST CIRCUIT

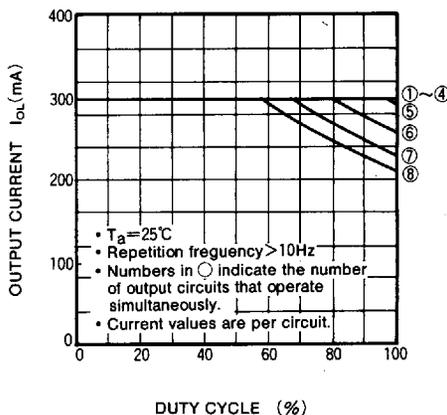


- Input waveform is taken as  $t_r \leq 20\text{ns}$  and  $t_f \leq 20\text{ns}$
- $C_L$  includes wiring stray capacitance and probe input capacitance.

THERMAL DERATING



DUTY CYCLE VS PERMISSIBLE OUTPUT CURRENT



DUTY CYCLE VS PERMISSIBLE OUTPUT CURRENT

